

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PRODUCT MAY BE PROTECTED BY ONE OR MORE OF THE FOLLOWING US PATENTS: REVISIONS THIS DRAWING AND THE SUBJECT MATTER SHOWN THEREON ARE CONFIDENTIAL AND THE PROPERTY 5736910 5939955 6425781 6428361 6554638 6840817 7123117 OF BEL/STEWART/TRP CONNECTOR AND SHALL NOT BE REPRODUCED, COPIED, OR USED IN ANY EC-1411035 COMPANY LOGO CHANGE 7429195 7717749 7808751 6217391 6149050 7924130 MANNER WITHOUT THE WRITTEN CONSENT OF TRP CONNECTOR. — .850 MAX **MECHANICAL**: 1 MATERIALS: \_\_\_.100 -HOUSING - THERMOPLASTIC PET POLYESTER FLAMMABILITY RATING UL 94V-0. -SHIELD - .010" THICK, C26800 BRASS PREPLATED WITH 30µINCH MIN SEMI-BRIGHT NICKEL, SOLDER TABS POST DIPPED WITH 100µINCH MIN SÁC SOLDER. -MOD JACK CONTACTS - 0.0157" x 0.018" PHOSPHOR BRONZE, 50µINCH MIN OVERALL NICKEL UNDERPLATE, WITH SELECT 50 µINCH MIN HARD GOLD FINISH PLATE. .625 .645 0 0 0 0 SOLDERTAILS WITH 100 µINCH MIN MATTE TIN AND/OR SAC SOLDER DIP. RJ45 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUB PART F. — .050 TYP 3 MAGNETICS -IMPEDANCE: 100 OHMS — .100 TYP -TURNS RATIO (CHIP:CABLE): TX = 1:1, RX = 1:1 -OPEN CIRCUIT INDUCTANCE (OCL): 350 \(\mu\)H MIN @100kHz, 0.1VRMS, 8mADC BIAS FROM 0°C TO 70°C, TX AND RX ----.725 MAX --PERFORMANCE @ 25°C: INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHz TO 100MHz Pin Designations RETURN LOSS (RL): 18dB MIN FROM 0.5MHZ TO 30MHZ 18-20LOG(f/30)dB MIN FROM 30.1MHz TO 60MHz 12dB MIN FROM 60.1MHz TO 80MHz CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz 33-20\*LOG(f/50)dB MIN FROM 40.1MHz TO 100MHz COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz -ISOLATION VOLTAGE: COMPLIES WITH IEEE802.3 2002, PARA 23.5.1.1, ITEM b. .600 MAX .555 4. OPERATING TEMPERATURE: FROM 0° TO +70°C. ┌ .020 INDICATED CONNECTIONS ARE FOR HUB CONFIGURATION. THE MAGNETICS ARE ASYMMETRIC, AND THEREFORE DO NOT SUPPORT AUTO-MDI/MDIX. TRP CONNECTOR LOGO, PART NUMBER, DATE CODE, COUNTRY OF ORIGIN AND AGENCY APPROVAL MARKING IN APPROXIMATE LOCATION SHOWN. **→** .425 **→** 7. THESE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PREHEAT .145±.010 — TEMPERATURE IS 120°C TO 160°C, 120 SECONDS TO 180 SECONDS, PEAK WAVE SOLDERING TEMPERATURE IS 260°C MAX, 10 SECONDS MAX. 8 OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER **-** .050 TYP D.RENAUD/D.SINISI 754 SERIES MAGNETIC CIRCUIT \_\_\_ ø.035(8X) Ø.062(2X) — 0 0 0 6 T RDP ⊗ RCT ø.126(2X) — 0 0 .575 +.015 TOP OF PCB-.350 — .272 MIN .250 <u></u> C1 — .450 —**→ Suggested Panel Cutout** CMC1 SHIELD SHIELD Suggested PCB Layout (Component Side) RJ-8

/8\OBSOLETE YES 6605783-1 DECOUPLING CAPACITOR PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT. ± -± -± .010 ± .005 ± -108-2100 CUSTOMER DRAWING

MAGJACK SINGLE NON-POE

NO

DONGGUAN CHINA 1X1 754 10/100 TAB UP W/O LED

06JAN2015 HY | KZ

RESTRICTED **C**-6605783

RXN

RXP

R1-R4 = 75 OHMS, 1/16 W RESISTORS

C1 = 1000 pF, 2kV CAPACITOR

TRP Connector